Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package name	Standard dimensions mm (inch)	Not Mounted
1	CN1, CN2, CN6	3	_	BM04B-PASS- TFT(LF)(SN)	JST	Terminal, 250 V, 3 A	_	_	
2	CN3	1	-	BM08B-PASS- TFT(LF)(SN)	JST	Terminal, 250 V, 3 A	_	-	
3	CN4, CN8	2	_	BM02B-PASS- TFT(LF)(SN)	JST	Terminal, 250 V, 3 A	_	_	
4	CN5	1	_	BM03B-PASS- TFT(LF)(SN)	JST	Terminal, 250 V, 3 A	_	_	
5	CN7	1	_	WR-60S-VFH05-N1	JAE	Terminal, 200 V, 0.3 A	_	_	
6	C1, C2, C3, C4, C9, C10, C14, C16, C17, C18, C24, C52, C64, C92, C104, C132, C159, C162, C164, C165, C168, C169, C174, C175, C176	25	1 µF			Ceramic, 10 V, ±10 %	1608	1.6 x 0.8 (0603)	
7	C5, C12, C161	3	330 pF			Ceramic, 50 V, ±5 %	1608	1.6 x 0.8 (0603)	
8	C6, C7, C8, C11, C13, C15	6	100 pF			Ceramic, 50 V, ±5 %	1608	1.6 x 0.8 (0603)	
9	C19, C20, C47, C48, C59, C60, C87, C88, C99, C100, C127, C128	12	10 µF			Ceramic, 50 V, ±20 %	3216	3.2 x 1.6 (1206)	
10	C21, C23, C25, C26, C49, C51, C53, C54, C61, C63, C65, C66, C89, C91, C93, C94, C101, C103, C105, C106, C129, C131, C133, C134	24	1 µF			Ceramic, 50 V, ±10 %	1608	1.6 x 0.8 (0603)	
11	C28, C56, C68, C96, C108, C136	6	3300 pF			Ceramic, 50 V, ±5 %	1608	1.6 x 0.8 (0603)	
12	C29, C57, C69, C97, C109, C137	6	10 µF			Ceramic, 25 V, ±10 %	2012	2.0 x 1.25 (0805)	
13	C30, C58, C70, C98, C110, C138	6	1 µF			Ceramic, 25 V, ±10 %	2012	2.0 x 1.25 (0805)	

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package name	Standard dimensions mm (inch)	Not Mounted
14	C31, C32, C33, C34, C39, C40, C41, C42, C71, C72, C73, C74, C79, C80, C81, C82, C111, C112, C113, C114, C119, C120, C121, C122	24	1 µF	СКG57NX7T2J105M 500JH	TDK	Metal Terminal Type Ceramic, 650 V, ±20 %	-	6.0 x 5.0	
15	C147, C148, C149, C150, C151, C152	6	470 µF	ESMR451VSN471MR40S	United Chemi- Con	Aluminum, 450 V, ±20 %	-	30.0 x 30.0	
16	C158, C163	2	470 pF			Ceramic, 50 V, ±5 %	1608	1.6 x 0.8 (0603)	
17	C160	1	1000 pF			Ceramic, 50 V, ±10 %	1005	1.0 x 0.5 (0402)	
18	C166, C167, C177	3	10 µF			Ceramic, 50 V, ±10 %	3216	3.2 x 1.6 (1206)	
19	D1, D3, D4, D5, D6, D8, D12, D17, D22, D27, D32, D37, D44, D45, D46, D47	16	30 V	CUS05F30	TOSHIBA	Schottky Barrier Diode	SOD- 323	2.5 x 1.25	
20	D9, D14, D19, D24, D29, D34, D48, D49, D50, D51, D52, D53	12	1000 V	CMF05	TOSHIBA	Rectifier Diode	M-FLAT	2.4 x 4.7	
21	D10, D15, D20, D25, D30, D35	6	30 V	CMS03	TOSHIBA	Schottky Barrier Diode	M-FLAT	2.4 x 4.7	
22	D11, D16, D21, D26, D31, D36	6	8.2 V	CRY82	TOSHIBA	Zener Diode	S-FLAT	1.6 x 3.5	
23	D13, D18, D23, D28, D33, D38	6	2.0 V-	KDZVTR2.0B	Rohm	Zener Diode	SOD- 123FL	3.5 x 1.6	
24	IC1, IC3, IC20	3	-	TLP7920(LF5,TP5)	TOSHIBA	Optically Isolation Amplifiers	-	12.0 x 9.66	
25	IC2	1	-	OPA4322AIPWR	Texas Instruments	Operational amplifier	TSSOP	5.00 x 4.40	
26	IC4	1	-	REF2025AIDDCT	Texas Instruments	Voltage Reference	SOT	2.90 × 1.60	
27	IC5, IC7, IC9, IC11, IC13, IC15	6	-	LP2951D	Txsas Instruments	Voltage Regulators	SOIC	4.90 x 3.90	
28	IC6, IC8, IC10, IC12, IC14, IC16	6	-	TLP5214A	TOSHIBA	Gate-Driver(Single)	SO16L	10.3 x 10.0	
29	IC19	1	-	OPA2322AID	Texas Instruments	Operational amplifier	SOIC	4.90 x 3.91	

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package name	Standard dimensions mm (inch)	Not Mounted
30	IC21, IC22	2	-	TC74VHC541FT	TOSHIBA	Buffer	TSSOP2 0B	6.5 x 6.4	
31	LED1	1	-	VCDG1111C-4BY3C-TR	STANLEY	LED	1608	1.6 x 0.8 (0603)	
32	L1	1	1µ H	MBKK1608T1R0M	Taiyo Yuden	0.8A	1608	1.6 x 0.8 (0603)	
33	PC1	1	-	TLP3558A(TP1,F	Toshiba	Photocoupler	DIP4	4.58 x 7.62	
34	PS1, PS9	2	-	H0505S-1WR2	MORNSUN	DC-DC Converter	-	19.50 x 9.80	
35	PS2, PS3, PS4, PS5, PS6, PS7	6	-	G2412S-2WR2	MORNSUN	DC-DC Converter	-	19.50 x 9.80	
36	PS10	1	-	MGFS102405	COSEL	DC-DC Converter	SOP8	17 x 8.5	
37	Q1, Q2, Q3, Q4, Q5, Q6	6	-	TW070J120B	TOSHIBA	SIC MOSFET	TO- 3P(N)	-	
38	R1, R2, R3, R4, R5, R14, R16, R17, R18, R19, R124, R125, R126, R127, R128	15	330 kΩ			125 mW, ±1 %	2012	2.0 x 1.2 (0805)	
39	R6, R23	2	430 Ω			100m W, ±1 %	1608	1.6 x 0.8 (0603)	
40	R7, R11, R20, R25	4	27 kΩ			100m W, ±1 %	1608	1.6 x 0.8 (0603)	
41	R8, R12, R15, R21	4	39 kΩ			100m W, ±1 %	1608	1.6 x 0.8 (0603)	
42	R9, R24, R131	3	0Ω			1 A	1608	1.6 x 0.8 (0603)	
43	R10, R22	2	10 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
44	R27, R132	2	47 kΩ			100 mW, ±5 %	1608	1.6 x 0.8 (0603)	
45	R28, R40, R52, R64, R76, R88	6	82 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
46	R29, R41, R53, R65, R77, R89	6	75 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
47	R30, R42, R54, R66, R78, R90	6	10 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
48	R31, R43, R55, R67, R79, R91, R149	7	470 Ω			100 mW, ±5 %	1608	1.6 x 0.8 (0603)	
49	R32, R39, R44, R51, R56, R63, R68, R75, R80, R87, R92, R99	12	10 kΩ			100 mW, ±5 %	1608	1.6 x 0.8 (0603)	

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package name	Standard dimensions mm (inch)	Not Mounted
50	R34, R36, R46, R48, R58, R60, R70, R72, R82, R84, R94, R96	12	3.3 Ω			1 W, ±5 %	6432	6.4 x 3.2 (2512)	
51	R35, R47, R59, R71, R83, R95, R121	7	1.0 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
52	R37, R38, R49, R50, R61, R62, R73, R74, R85, R86, R97, R98	12	6.8 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
53	R110, R113, R114, R118	4	100 kΩ			5 W, ±5 %	Axial	8.5 x 26	
54	R119	1	20 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
55	R120, R129	2	36 kΩ			100 mW, ±1 %	1608	1.6 × 0.8 (0603)	
56	R122, R123	2	12 kΩ			100 mW, ±1 %	1608	1.6 x 0.8 (0603)	
57	R130	1	360 Ω			100 mW, ±1 %	1608	1.6 × 0.8 (0603)	
58	R133	1	470 Ω			100 mW, ±1 %	1608	1.6 × 0.8 (0603)	
59	R134, R135, R136, R137, R138, R139, R140	7	10 kΩ			100 mW, ±1 %	1608	1.6 × 0.8 (0603)	
60	R141, R143, R144	3	4.7 kΩ			100 mW, ±5 %	1608	1.6 × 0.8 (0603)	
61	R142, R146, R147	3	100 Ω			100 mW, ±1 %	1608	1.6 x 0.8(0603)	
62	R150	1	1 kΩ			125 mW, ±5 %	1608	1.6 x 0.8 (0603)	
63	TB1, TB2, TB3, TB6, TB7	5	-	OT-264	Osada	Terminal, 50 A	-	10 x 8	

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package name	Standard dimensions mm (inch)	Not Mounted
64	TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP15, TP16, TP17, TP18, TP19, TP20, TP21, TP22, TP23, TP24, TP25, TP26, TP27, TP28, TP29, TP30, TP31, TP32, TP33, TP34, TP41, TP42, TP43, TP44, TP45, TP46, TP47, TP48, TP49, TP50, TP51, TP52, TP53, TP54	48		HK-3-G	MAC8	Test Pin	-	2.0 x 1.3	
901	C22, C27, C50, C55, C62, C67, C90, C95, C102, C107, C130, C135, C170, C171, C172	15	_	_	_	_	1608	1.6 x 0.8 (0603)	Not Mounted
902	D2 ,D7	2	_	CUS05F30	TOSHIBA	Schottky Barrier Diode	USC	2.5 x 1.25	Not Mounted
903	R13, R26, R33, R45, R57, R69, R81, R93	8	_	_	_	-	1608	1.6 x 0.8 (0603)	Not Mounted

### Terms of Use

This terms of use is made between Toshiba Electronic Devices and Storage Corporation ("We") and customers who use documents and data that are consulted to design electronics applications on which our semiconductor devices are mounted ("this Reference Design"). Customers shall comply with this terms of use. Please note that it is assumed that customers agree to any and all this terms of use if customers download this Reference Design. We may, at its sole and exclusive discretion, change, alter, modify, add, and/or remove any part of this terms of use at any time without any prior notice. We may terminate this terms of use at any time and for any reason. Upon termination of this terms of use, customers shall destroy this Reference Design. In the event of any breach thereof by customers, customers shall destroy this Reference Design, and furnish us a written confirmation to prove such destruction.

#### 1. Restrictions on usage

1. This Reference Design is provided solely as reference data for designing electronics applications. Customers shall not use this Reference Design for any other purpose, including without limitation, verification of reliability.

2. This Reference Design is for customer's own use and not for sale, lease or other transfer.

3. Customers shall not use this Reference Design for evaluation in high or low temperature, high humidity, or high electromagnetic environments.

4. This Reference Design shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.

#### 2. Limitations

1. We reserve the right to make changes to this Reference Design without notice.

2. This Reference Design should be treated as a reference only. We are not responsible for any incorrect or incomplete data and information.

3. Semiconductor devices can malfunction or fail. When designing electronics applications by referring to this Reference Design, customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of semiconductor devices could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Customers must also refer to and comply with the latest versions of all relevant our information, including without limitation, specifications, data sheets and application notes for semiconductor devices, as well as the precautions and conditions set forth in the "Semiconductor Reliability Handbook".

4. When designing electronics applications by referring to this Reference Design, customers must evaluate the whole system adequately. Customers are solely responsible for all aspects of their own product design or applications. WE ASSUME NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.

5. No responsibility is assumed by us for any infringement of patents or any other intellectual property rights of third parties that may result from the use of this Reference Design. No license to any intellectual property right is granted by this terms of use, whether express or implied, by estoppel or otherwise.

6. THIS REFERENCE DESIGN IS PROVIDED "AS IS". WE (a) ASSUME NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (b) DISCLAIM ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO THIS REFERENCE DESIGN, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.

### 3. Export Control

Customers shall not use or otherwise make available this Reference Design for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). This Reference Design may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of this Reference Design are strictly prohibited except in compliance with all applicable export laws and regulations.

### 4. Governing Laws

This terms of use shall be governed and construed by laws of Japan.